Supplier Name: Infiniti Solutions Pte. Ltd.
Company Address: Hologram St. LISP I of the Philippines, Cabuyao Laguna
Responder Contact Name: Rod Sanico
Responder Contact Phone: (+6349) 543-0333 ext. 109
Responder Contact email: rsanico@infinitisolutions.com
Responder Title: QA Director
Date of Response: 30Oct.2008

Responder Signature:

Instructions

Suppliers must provide the identity and % weight of ALL substances of very high concern (SVHC) present in products supplied to Maxim. SVHCs are defined by REACH Article 57 and in accordance with Directive 67/548/EEC. The criteria is set out in REACH Annex XIII. For more information see http://ec.europa.eu/environment/chemicals/reach/reach_intro.htm .

The list of SVHC substances is only for the currently known candidate listing as of Oct 1 2008. Additional updates to this listing are expected and additional requests for data on those new substances as added will be sent.

Data is to supplied for each material type/formulation used in our products. Where multiple suppliers are used, worse case data (highest value) should be shown. Examples: Material Type = Mold Compound, Name/Formula = Sumitomo EME-G600. Material Type = Leadframe, Name/Formula = Cu alloy C194.

Where there is no content of the substance, enter 0%.
Insert additional rows as needed to reflect content of substances per material used.

		% Weight of Substance/CAS number																		
		Anthracene (CAS No. 120-12-7)	4,4'-diaminodiphenylmethane (CAS No. 101-77-9)	Dibutyl phthalate (DBP) (CAS No. 84-74-2)	Cyclododecane (CAS No. 294-62-2)	Cobalt dichloride (CAS No. 7546-79-9)	Diarsenic pentaoxide (CAS No. 1303-28-2)	Diarsenic trioxide (CAS No. 1327-53-3)	Sodium dichromate, dihydrate (CAS No. 7789-12-0)	5-tert-butyl-2,4,6-trinitro-m-xylene (musk xylene) (CAS No. 81-15-2)	Bis (2-ethyl(hexyl)phthalate) (DEHP) (CAS No. 117-81-7)	Hexabromocyclodecane (HBCDD) (CAS No. 25637-99-4)	Short chain chlorinated paraffins (SCCPs) (CAS No. 85535-84-8)	Bis(tributyltin)oxide (CAS No. 56-35-9)	Lead hydrogen arsenate (CAS No. 7784-40-9)	Triethyl arsenate (CAS No. 15606-95-8)	Benzyl butyl phthalate (BBP) (CAS No. 85-68-7)	Certification	Status of Data	Supplier
Material Type	Die Attach Epoxy																			
Material Name/Formula	AB 84-1LMIS R4 C, 10CC, TECHON	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			
Material Type	Die Attach Epoxy																			
Material Name/Formula	AB 8290, C, 10CC,EFD	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	Certification_Ablestik		ABLESTIK
Material Type	Die Attach Epoxy																			
Material Name/Formula	AB 84-3J, 10CC, TECHON	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			
Material Type	Lead Frame																			
Material Name/Formula	LF - SOT23 3L	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			JADE
Material Type	Lead frame																			
Material Name/Formula	LF- SOT23 5L 66X47.6																			
Material Type	Lead frame																			
Material Name/Formula	LF- SOT23 6L 66X39																		Communication in-progress	ASM ASSY
Material Type	Lead frame																			
Material Name/Formula	LF- TSOT23 5L 66X47.6																			
Material Type	Lead frame																			
Material Name/Formula	LF- TSOT23 5L 66X39																			
Material Type	Lead frame																			
Material Name/Formula	LF- TDFN/TQFN	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%		Awaiting for the COC	ASM TECH
Material Type	Bonding Wire																			
Material Name/Formula	AU, H 1.0MIL LL HD5	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			HEREAUS
Material Type	Bonding Wire																		Awaiting for the COC	
Material Name/Formula	AU, H 1.3MIL LL HD5	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			
Material Type	Molding Compound																			
Material Name/Formula	MC MP8000AN 16MMX9.2G	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%		Awaiting for the COC	NITTO
Material Type	Molding Compound																			
Material Name/Formula	MC G77OHCD 16MMX8.6G GRN																			
Material Type	Molding Compound																		Communication in-progress	SUMITOMO
Material Name/Formula	MC 6300H, 18X12.3																			
Material Type	Molding Compound																			
Material Name/Formula	Cookson-Plaskon CK5000A	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			
Material Type	Molding Compound																		Awaiting for the COC	COOKSON
Material Name/Formula	Cookson-Plaskon CK6510 series	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			
Material Type	Mark Ink																			
Material Name/Formula	Markem 4488																		Communication in-progress	MARKEM
Material Type	Plating Material																		Awaiting for the COC	AEM
Material Name/Formula	Anode Balls Sn/Pb	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			PLATRONICS
Material Type	Plating Material																			
Material Name/Formula	100% TIN BUTTON, DIA 25MM	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%	0%			TECHNIC